Technical Specifications



ITEM	E2		
CONSTRUCTION	Build Volume*(W×D×H)		
	Single Extruder Print	Dual Extruder Print	
	13×9.4×9.4 inch / 330×240×240	mm 11.6×9.4×9.4 inch / 295×240×240 mm	
	Machine Size (W×D×H)		
	23.9×23.5×18.3 inch / 607×596×465 mm		
ELECTRICAL	Power Supply Input Power Supply Output	100-240 V AC, 50/60 Hz 230 V @ 2 A 24 V DC, 350 W	
PRINTER	Print Technology Print Head System Filament Diameter XYZ Step Size Print Head Travel Speed Build Plate Max Build Plate Temperature Heated Bed Material Build Plate Leveling Supported Materials Layer Height Nozzle Diameter Hot End Max Nozzle Temperature Connectivity Noise Emission (Acoustic) Operating Ambient Temperature Storage Temperature Technical Certifications Filter	Independent Dual Extruders 1.75 mm 0.78125, 0.78125, 0.078125 micron 30 - 150 mm/s Flexible Steel Plate with Buildtak 110 °C Silicone Mesh-leveling with Flatness Detection PLA/ ABS/ HIPS/ PC/ TPU/ TPE/ NYLON/ PETG/ ASA/ PP/ PVA/ Glass Fiber Infused/ Carbon Fiber Infused/ Metal Fill/ Wood Fill 0.02 - 0.25 mm 0.4 mm (Default), 0.2/ 0.6/ 0.8/ 1.0 mm (Available) V3P (V3 hotend with PTFE version) 300 °C Wi-Fi, LAN, USB port, Live camera < 50 dB(A) when building 15 - 30 °C, 10 - 90% RH non-condensing -25 to 55 °C, 10 - 90% RH non-condensing CB, CE, FCC, RoHS, RCM HEPA filter with activated charcoal	
SOFTWARE	Slicing Software Supported File Types Supported OS Machine Code Type	ideaMaker STL/ OBJ/ 3MF Windows/ macOS/ Linux GCODE	
PRINTER CONTROLLER	User Interface Network Resume Print after Power Outage Screen Resolution Motion Controller Logic Controller Memory Onboard Flash OS Ports	7-inch Touch Screen Wi-Fi, Ethernet Firmware recording, no need for battery installation. 1024×600 Atmel ARM Cortex-M4 120MHz FPU NXP ARM Cortex-A9 Quad 1 GHz 1 GB 8 GB Embedded Linux USB 2.0×2, Ethernet×1	

 $^{^{\}star}$ The build volume of the E2 is not cuboid. For more details, please click here.